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ON Semiconductor®

FQT1N80TF-WS

N-Channel QFET® MOSFET

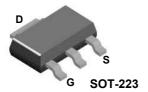
800V, 0.2 A, 20 Ω

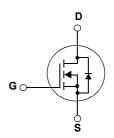
Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor® s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce onstate resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 0.2 A, 800 V, $R_{DS(on)}$ =15.5 $\Omega(V^{\hat{}}]$.)@ V_{GS} =10 V, I_D =0.1 A
- Low Gate Charge (Typ. 5.5 nC)
- Low C_{rss} (Typ. 2.7 pF)
- 100% Avalanche Tested
- · RoHS Compliant





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol		Parameter		FQT1N80TF-WS	Unit	
V_{DSS}	Drain to Source Voltage	Drain to Source Voltage		800	V	
V_{GSS}	Gate to Source Voltage	to Source Voltage		±30	V	
	Drain Current	-Continuous (T _C = 25°C)		0.2	^	
ID	Drain Current	-Continuous (T _C = 100°C)		0.12	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	0.8	Α	
E _{AS}	Single Pulsed Avalanche E	Energy	(Note 2)	90	mJ	
I _{AR}	Avalanche Current (Note		(Note 1)	0.2	Α	
E _{AR}	Repetitive Avalanche Energy (No		(Note 1)	0.2	mJ	
dv/dt	Peak Diode Recovery dv/c	It	(Note 3)	4.0	V/ns	
Б	Dawer Dissipation	(T _C = 25°C)		2.1	W	
P_{D}	Power Dissipation	- Derate above 25°C		0.02	W/°C	
T _J , T _{STG}	Operating and Storage Ter	mperature Range		-55 to +150	οС	
T _L	Maximum Lead Temperatu 1/8" from Case for 5 Second			300	°C	

Thermal Characteristics

Symbol	Parameter	Min.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient*	-	60	°C/W

^{*} When mounted on the minimum pad size recommended (PCB Mount)

Package Marking and Ordering Information T_C = 25°C unless otherwise noted

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FQT1N80	FQT1N80TF-WS	SOT-223	330mm	12mm	4000

Electrical Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A$, $V_{GS} = 0 V$, $T_J = 25 ^{\circ} C$	800	-	-	V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25°C	-	0.8	-	V/°C
	Zara Cata Valtaga Drain Current	V _{DS} = 800V, V _{GS} = 0V	-	-	25	μА
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 640V, T_C = 125^{\circ}C$	-	-	250	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 0.1A$	-	15.5	20	Ω
g _{FS}	Forward Transconductance	$V_{DS} = 40V, I_D = 0.1A$ (Note 4)	-	0.75	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 05V V 0V	V _{DS} = 25V, V _{GS} = 0V f = 1MHz	-	150	195	pF
C _{oss}	Output Capacitance			-	20	30	pF
C _{rss}	Reverse Transfer Capacitance	1 - 11/11/12		-	2.7	5.0	pF
Q_g	Total Gate Charge at 10V			-	5.5	7.2	nC
Q _{gs}	Gate to Source Gate Charge	$V_{DS} = 640V, I_{D} = 1A$	$V_{DS} = 640V, I_{D} = 1A$	-	1.1	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	V _{GS} = 10V	(Note 4, 5)	-	3.3	-	nC

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	10	30	ns
t _r	Turn-On Rise Time	$V_{DD} = 400V, I_{D} = 1A$	-	25	60	ns
t _{d(off)}	Turn-Off Delay Time	$R_G = 25\Omega$	-	15	40	ns
t _f	Turn-Off Fall Time	(Note 4, 5)	-	25	60	ns

Drain-Source Diode Characteristics

I _S	Maximum Continuous Drain to Source Diode Forward Current			-	0.2	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	0.8	Α
V_{SD}	Drain to Source Diode Forward Voltage	Drain to Source Diode Forward Voltage $V_{GS} = 0V$, $I_{SD} = 0.2A$		-	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _{SD} = 1A	-	300	-	ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$ (Note	4) -	0.6	-	μС

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 170mH, I_{AS} = 1A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 3. I $_{SD} \leq$ 1A, di/dt \leq 200A/ μ s, V $_{DD} \leq$ BV $_{DSS},$ Starting T $_{J}$ = 25°C
- 4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$
- 5. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

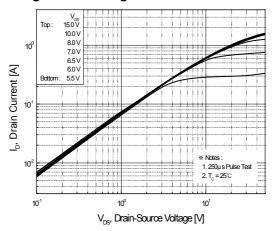


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

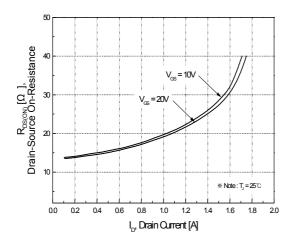


Figure 5. Capacitance Characteristics

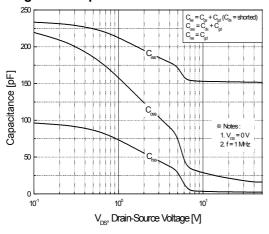


Figure 2. Transfer Characteristics

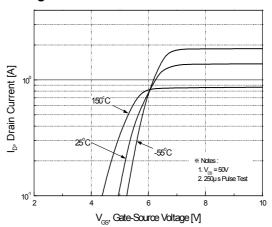


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

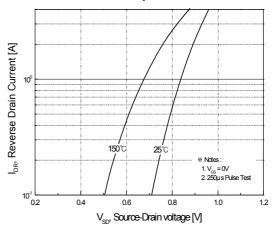
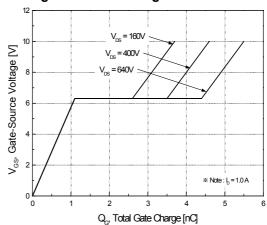


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

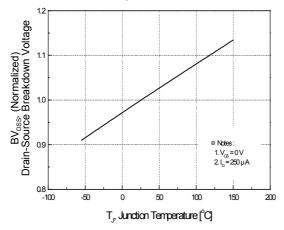


Figure 8. On-Resistance Variation vs. Temperature

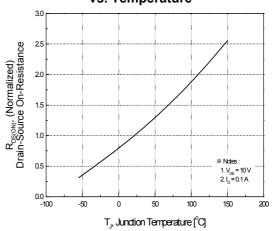


Figure 9. Maximum Safe Operating Area

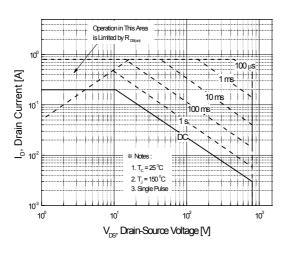


Figure 10. Maximum Drain Current vs. Case Temperature

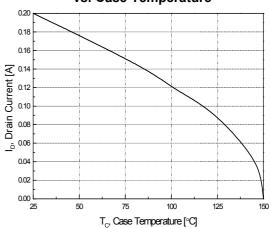
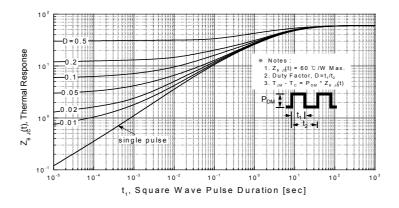
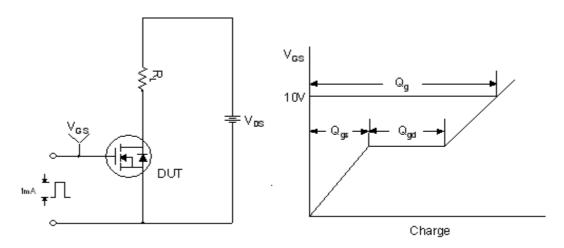


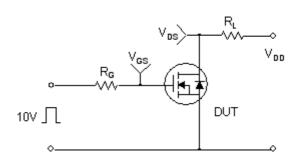
Figure 11. Transient Thermal Response Curve

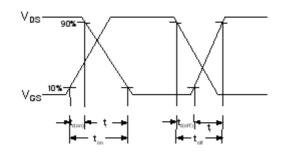


Gate Charge Test Circuit & Waveform

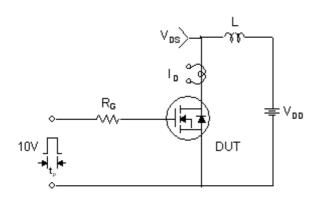


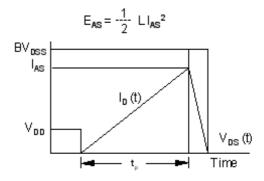
Resistive Switching Test Circuit & Waveforms



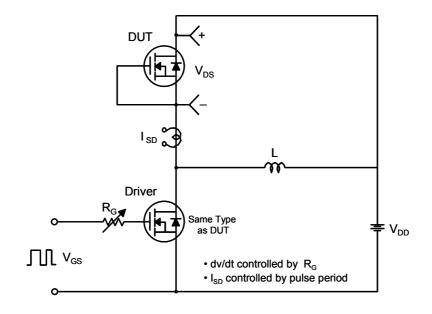


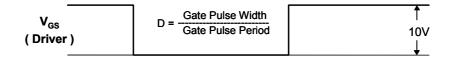
Unclamped Inductive Switching Test Circuit & Waveforms

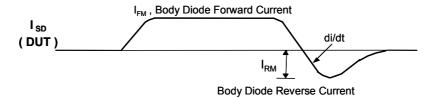




Peak Diode Recovery dv/dt Test Circuit & Waveforms







Body Diode Recovery dv/dt

V_{SD}

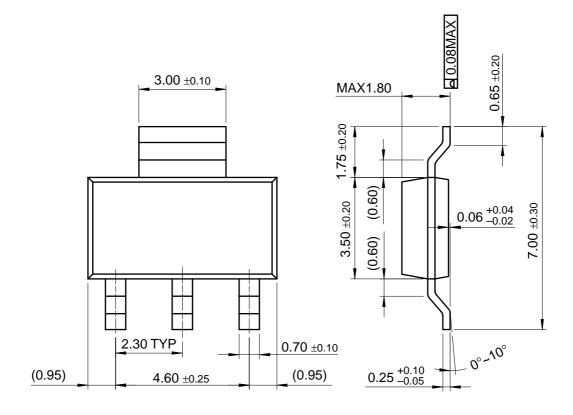
Body Diode

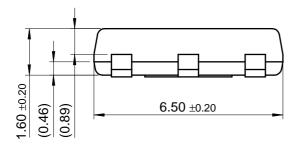
Body Diode

Forward Voltage Drop

Mechanical Dimensions

SOT-223





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